

TX Gain Control Amplifier

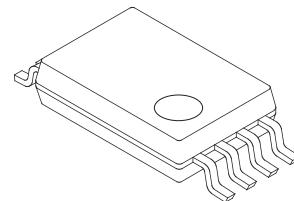
Description

CXA3222AN is a TX gain control amplifier suitable for CDMA cellular/PCS phone.

Features

- Wide gain control range
- Linear gain slope
- Wideband operation (50 MHz to 300 MHz)
- Very small package (8 Pin SSOP)
- Low voltage operation
- High output IP3
- Power save function included

8 pin SSOP (Plastic)



Absolute Maximum Ratings

• Supply voltage	Vcc	6	V
• Operating temperature	Topr	-55 to +125	°C
• Storage temperature	Tstg	-65 to +150	°C
• Supply voltage range		-0.3 to 6	V
• Logic input voltage		-0.3 to Vcc + 0.3 V	
• Signal input voltage		-0.3 to Vcc + 0.3 V	
• Differential signal input voltage		0 to 2.5	V

Operating Condition

Supply voltage Vcc 2.7 to 3.8 V

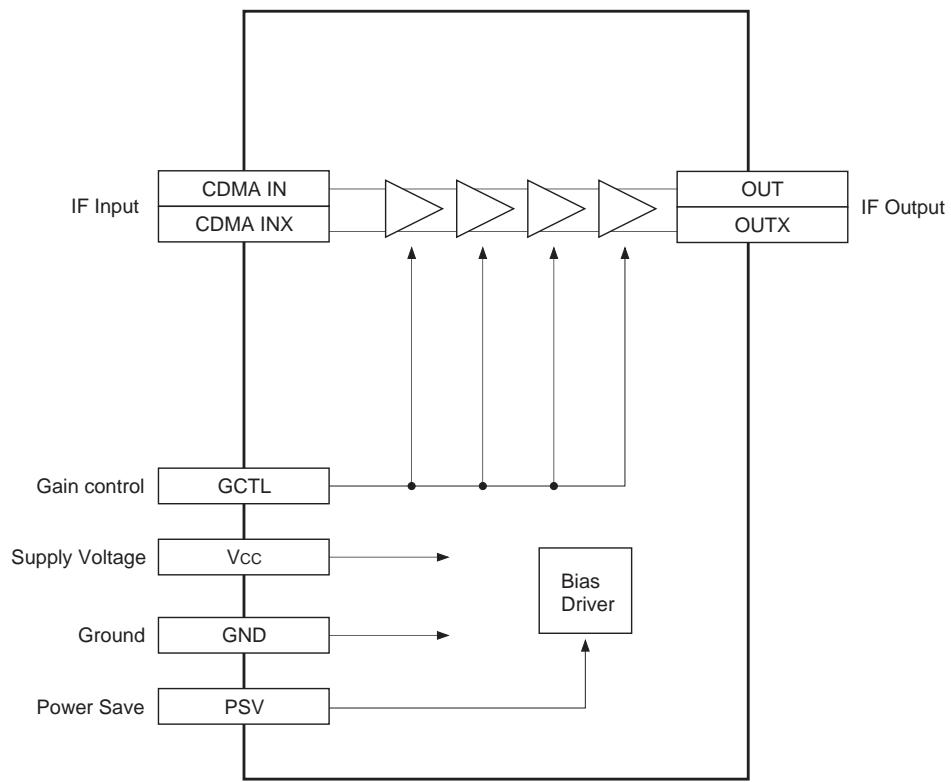
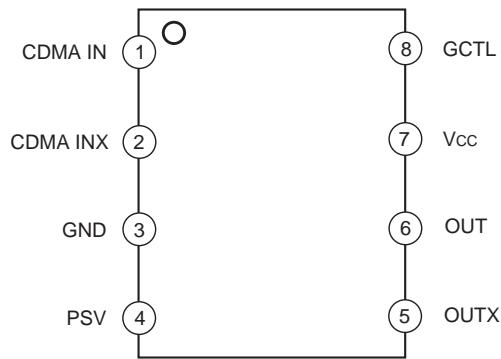
Applications

CDMA cellular/PCS phone

Structure

Bipolar silicon monolithic IC

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Block Diagram**Pin Configuration**

Pin Description

Pin No.	Symbol	Pin voltage TYP (V)	Equivalent circuit	Description
1	CDMA IN	1.1		Differential input pins for CDMA transmit IF signal.
2	CDMA INX	1.1		
3	GND	0		Ground.
4	PSV	—		Power save function pin. High: Active Low: Power save
5	OUTX	—		Differential output pins for transmit IF signal.
6	OUT	—		Open collector output.
7	Vcc	3.0		Positive power supply.
8	GCTL	—		Gain control pin.

Electrical Characteristics**DC Characteristics**

(Vcc=3.0 V, Ta=27 °C)

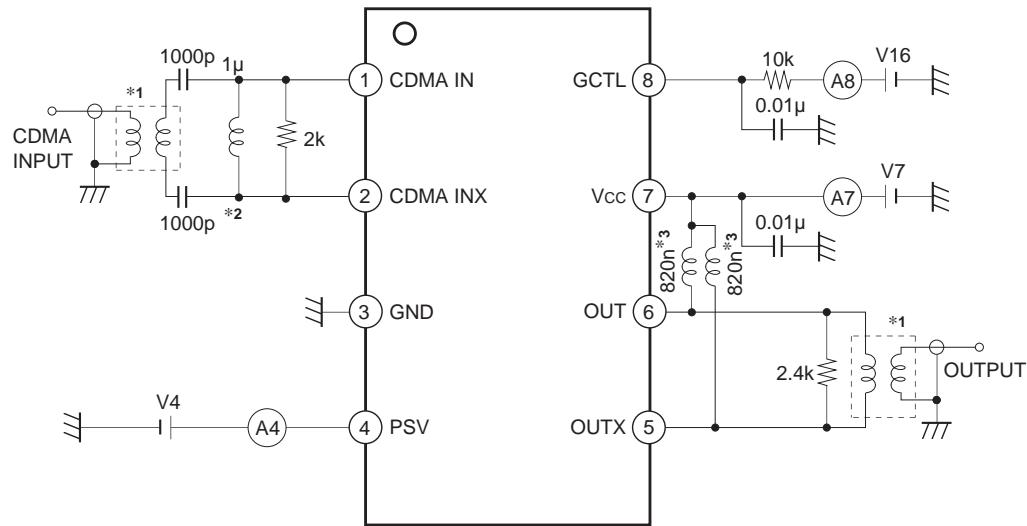
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Current consumption 1	Icc1	Vpsv=3.0 V, Vgctl=1.5 V, Pin 7	10	15.7	21.5	mA
Current consumption 2	Icc2	Vpsv=0 V, Vgctl=1.5 V, Pin 7	5	18	40	µA
Input current pin 4H	IpsvH	Vpsv=3.0 V			1	
Input current pin 4L	IpsvL	Vpsv=0 V	-15			
Input current pin 8H	IgctlH	Vgctl=3.0 V			1	
Input current pin 8L	IgctlL	Vgctl=0.5 V	-1			
PSV high voltage	VpsH	Pin 4	2.5			
PSV low voltage	VpsL	Pin 4			0.5	V

AC Characteristics

(Vcc=3.0 V, Ta=27 °C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Operating frequency range	Fr		50		300	MHz
Gain 2.3	G2.3	f=130.38 MHz, level=-22.5 dBm, Vgctl=2.3 V	13	17	21	dB
Gain 1.5	G1.5	Vgctl=1.5 V	-28	-24	-20	
Gain 1.0	G1.0	Vgctl=1.0 V	-58	-54	-50	
Gain 0.7	G0.7	Vgctl=0.7 V	-75	-70	-65	
Gain slope	GCLIN	Gain at Vgctl=2.0 V – Gain at Vgctl=1.0 V	57	60	63	dB/V
Input level 3rd order intercept point	IIP3	G=15 dB *1 f1=129.38 MHz, f2=131.38 MHz Measure of 130.38 MHz	-8.5	-4.5		dBm
Noise Figure	NF	G=15 dB *1 Measure of 130.38 MHz		28	32	dB

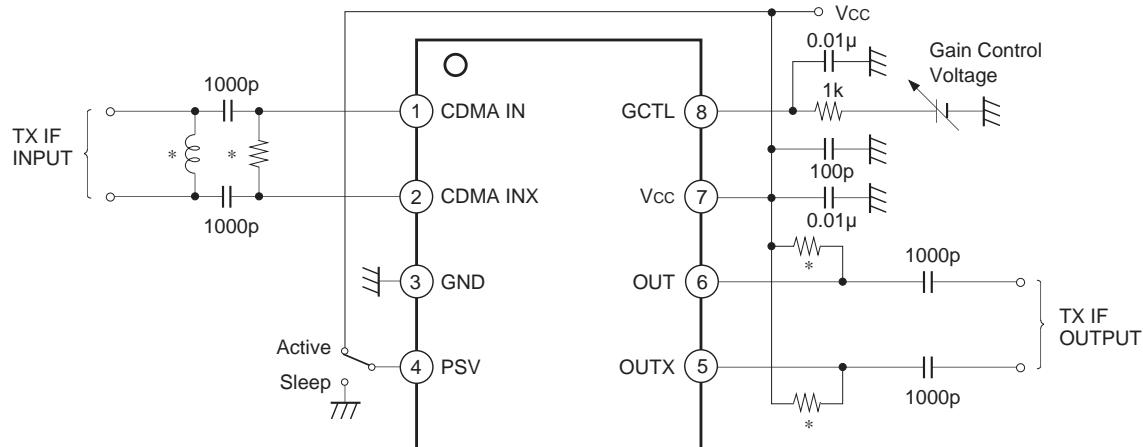
*1 Adjust GCTL voltage, and set the overall gain to 15 dB.

Measurement Circuit

*1 TOKO, Inc. B5FL 616DS-1135

*2 Coilcraft, Inc. 1008HS-102TKBC

*3 Coilcraft, Inc. 1008HS-821TKBC

Application Circuit

* Must be adjusting values to result a best impedance matching between BPF filter and this IC.

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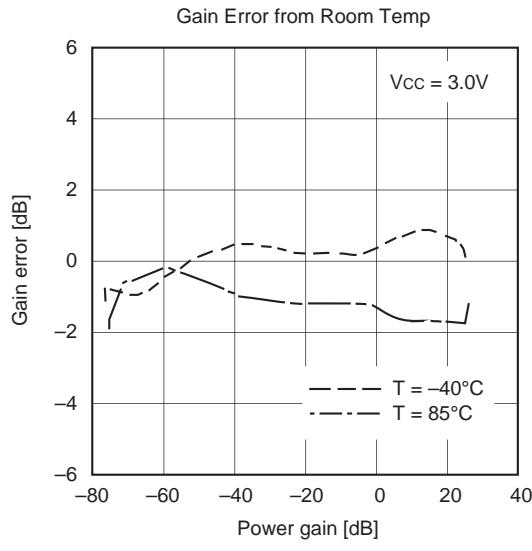
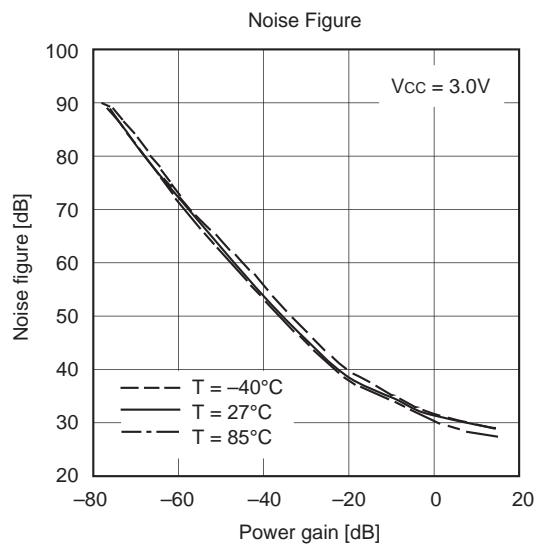
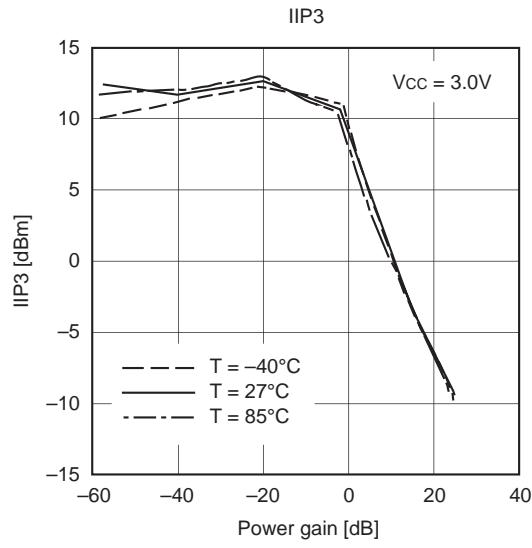
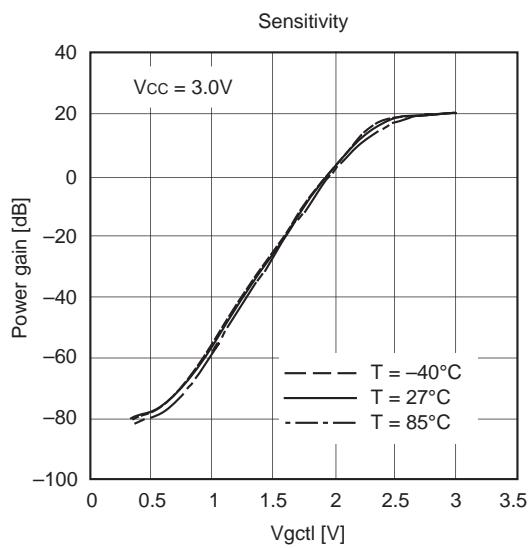
Design Reference Values**Single ended measurement**

(Vcc=3.0 V, Ta=27 °C)

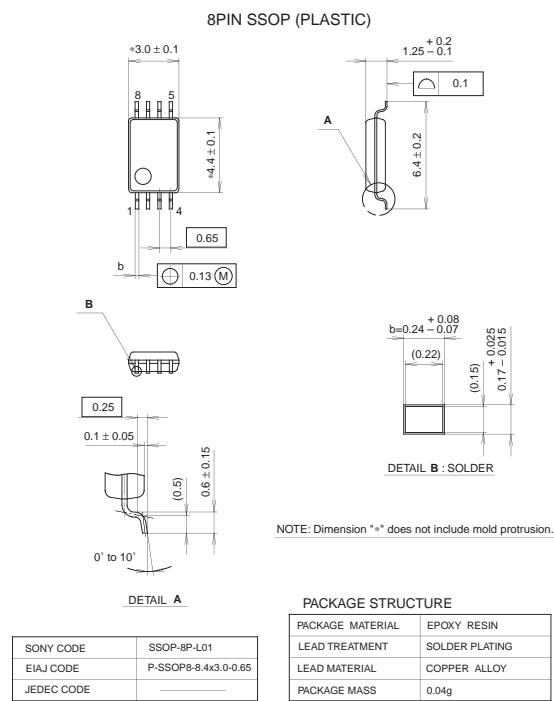
Item	Symbol	Conditions	Typ.	Unit
Input resistance	Rin	f=130.38 MHz, Vgctl=1.5 V	10	kΩ
Input capacitance	Cin		0.92	pF
Output resistance	Rout		6	kΩ
Output capacitance	Cout		0.9	pF

Notes on Operation

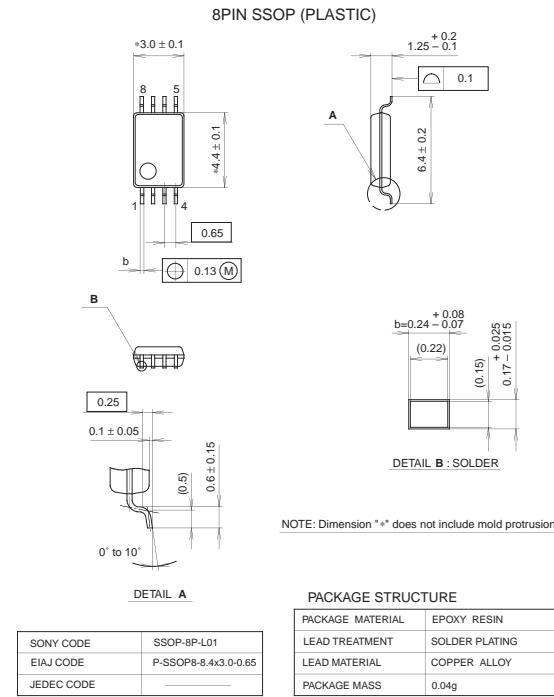
- 1) This IC is a wideband amplifier with wide gain control range. The decoupling capacitors between GND Pin and Vcc Pin should be as close to the IC as possible.
- 2) The resistors connected to Pins 5 and 6 should be as close to the IC as possible.
- 3) This IC assumes the excellent characteristics when the differential input impedance between Pins 1 and 2 is 500Ω. Refer to the Measurement Circuit for the external element settings, etc.
- 4) Pay attention to handling this IC because its electrostatic discharge strength is weak.



Package Outline Unit : mm



SCT Ass'y



LEAD PLATING SPECIFICATIONS	
ITEM	SPEC.
LEAD MATERIAL	COPPER ALLOY
SOLDER COMPOSITION	Sn-Bi Bi:1-4wt%
PLATING THICKNESS	5-18μm